



Features

- Fast tripping resettable circuit protection
- Surface mount packaging for automated assembly
- Small footprint size (1210)
- RoHS compliant* and halogen free**
- Agency recognition*   

Applications

- Game consoles
- PC motherboards
- USB port protection - USB 2.0, 3.0 & OTG
- HDMI 1.4 Source protection
- IEEE 1394 ports
- Mobile phones
- Digital cameras

MF-USMF Series - PTC Resettable Fuses

Electrical Characteristics

Model	V max. Volts	I max. Amps	I _{hold}	I _{trip}	Resistance		Max. Time To Trip		Tripped Power Dissipation
			Amperes at 23 °C		Ohms at 23 °C		Amperes at 23 °C	Seconds at 23 °C	Watts at 23 °C
			Hold	Trip	R _{Min.}	R _{1Max.}			Typ.
MF-USMF005	30	10	0.05	0.15	2.800	50.000	0.25	1.50	0.6
MF-USMF010	30	10	0.10	0.30	0.800	15.000	0.50	0.60	0.6
MF-USMF020	30	10	0.20	0.40	0.400	5.000	8.00	0.02	0.6
MF-USMF035	6	40	0.35	0.75	0.200	1.300	8.00	0.20	0.6
MF-USMF050	13.2	40	0.50	1.00	0.180	0.900	8.00	0.10	0.6
MF-USMF075	6	40	0.75	1.50	0.070	0.450	8.00	0.10	0.6
MF-USMF110	6	40	1.10	2.20	0.050	0.210	5.00	1.00	0.6
MF-USMF150	6	40	1.50	3.00	0.030	0.110	5.00	5.00	0.6
MF-USMF175X***	6	40	1.75	3.50	0.020	0.090	8.00	1.00	0.7

*** CSA approval pending.

Environmental Characteristics

Operating Temperature.....	-40 °C to +85 °C
Maximum Device Surface Temperature in Tripped State	125 °C
Passive Aging	+85 °C, 1000 hours..... ±5 % typical resistance change
Humidity Aging	+85 °C, 85 % R.H. 1000 hours..... ±5 % typical resistance change
Thermal Shock	+85 °C to -40 °C, 20 times..... ±10 % typical resistance change
Solvent Resistance.....	MIL-STD-202, Method 215..... No change
Vibration	MIL-STD-883C, Method 2007.1, No change Condition A

Test Procedures And Requirements For Model MF-USMF Series

Test	Test Conditions	Accept/Reject Criteria
Visual/Mech.	Verify dimensions and materials	Per MF physical description
Resistance	In still air @ 23 °C.....	R _{min} ≤ R ≤ R _{1max}
Time to Trip.....	At specified current, V _{max} , 23 °C	T ≤ max. time to trip (seconds)
Hold Current.....	30 min. at I _{hold}	No trip
Trip Cycle Life.....	V _{max} , I _{max} , 100 cycles.....	No arcing or burning
Trip Endurance	V _{max} , 48 hours.....	No arcing or burning
Solderability.....	ANSI/J-STD-002.....	95 % min. coverage
UL File Number	E174545 http://www.ul.com/ Follow link to Certifications, then UL File No., enter E174545	
CSA File Number.....	CA110338 http://directories.csa-international.org/ Under "Certification Record" and "File Number" enter 110338-0-000	
TÜV Certificate Number	R 02057213 http://www.tuvdotcom.com/ Follow link to "other certificates", enter File No. 2057213	

*RoHS Directive 2002/95/EC Jan 27 2003 including Annex.

**To be considered halogen free, each homogenous material can have a maximum concentration of 900 ppm of either bromine or chlorine.

Specifications are subject to change without notice.

Customers should verify actual device performance in their specific applications.

MF-USMF Series - PTC Resettable Fuses

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Product Dimensions

Model	A		B		C		D
	Min.	Max.	Min.	Max.	Min.	Max.	Min.
MF-USMF005	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.80}{(0.031)}$	$\frac{1.1}{(0.043)}$	$\frac{0.30}{(0.012)}$
MF-USMF010	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.80}{(0.031)}$	$\frac{1.1}{(0.043)}$	$\frac{0.30}{(0.012)}$
MF-USMF020	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.80}{(0.031)}$	$\frac{1.1}{(0.043)}$	$\frac{0.30}{(0.012)}$
MF-USMF035	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.55}{(0.022)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$
MF-USMF050	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.55}{(0.022)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$
MF-USMF075	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.55}{(0.022)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$
MF-USMF110	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.55}{(0.022)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$
MF-USMF150	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.40}{(0.016)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$
MF-USMF175X	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.40}{(0.016)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$

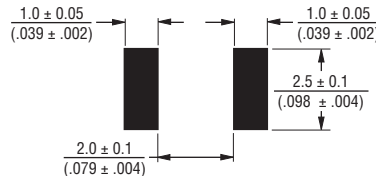
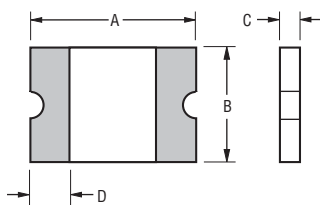
Packaging: 3000 pcs. per reel.

DIMENSIONS: $\frac{\text{MM}}{\text{(INCHES)}}$

Top and Bottom View

Side View

Recommended Pad Layout



Terminal material:

Electroless Ni under immersion Au

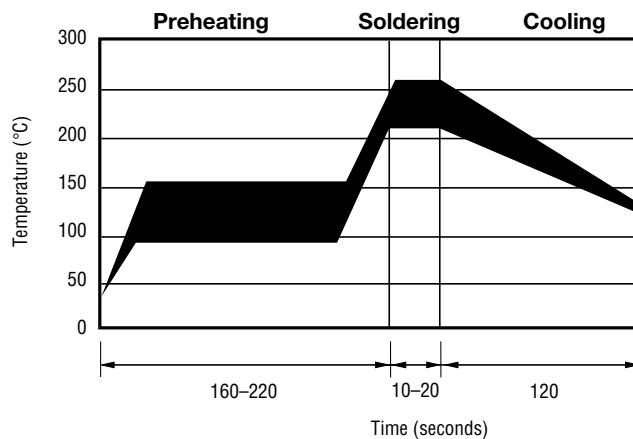
Termination pad solderability:

Standard Au finish:
Meets ANSI/J-STD-002 Category 2.

Recommended Storage:

40 °C max./70 % RH max.

Solder Reflow Recommendations



Notes:

- MF-USMF models cannot be wave soldered.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Compatible with Pb and Pb-free solder reflow profiles.
- Excess solder may cause a short circuit, especially during hand soldering. Please refer to the Multifuse® Polymer PTC Soldering Recommendation guidelines.

Specifications are subject to change without notice.
Customers should verify actual device performance in their specific applications.

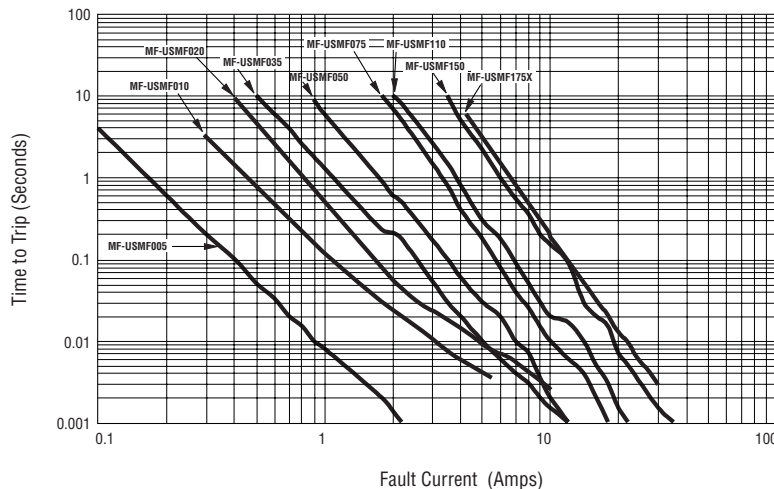
MF-USMF Series - PTC Resettable Fuses

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Thermal Derating Chart - I_{hold} (Amps)

Model	Ambient Operating Temperature								
	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C
MF-USMF005	0.08	0.07	0.06	0.05	0.04	0.04	0.03	0.03	0.02
MF-USMF010	0.15	0.13	0.12	0.10	0.09	0.08	0.07	0.06	0.05
MF-USMF020	0.32	0.28	0.24	0.20	0.18	0.16	0.14	0.12	0.10
MF-USMF035	0.51	0.46	0.40	0.34	0.30	0.27	0.24	0.22	0.18
MF-USMF050	0.76	0.66	0.58	0.48	0.42	0.38	0.35	0.29	0.23
MF-USMF075	1.10	0.97	0.86	0.72	0.64	0.58	0.55	0.47	0.39
MF-USMF110	1.60	1.42	1.26	1.10	0.94	0.86	0.80	0.70	0.58
MF-USMF150	2.30	2.02	1.76	1.43	1.24	1.11	1.00	0.85	0.65
MF-USMF175X	2.80	2.45	2.10	1.75	1.55	1.45	1.35	1.25	1.10

Typical Time to Trip at 23 °C



The Time to Trip curves represent typical performance of a device in a simulated application environment. Actual performance in specific customer applications may differ from these values due to the influence of other variables.

How to Order

MF - USMF 010 X - 2

Multifuse® Product Designator _____

Series _____
 USMF = 1210 Surface Mount Component

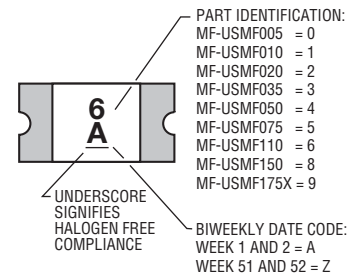
Hold Current, I_{hold} _____
 005-175 (0.05-1.75 Amps)

Multifuse® freeXpansion™ Design _____

Packaging _____
 Packaged per EIA 481-1
 -2 = Tape and Reel

Typical Part Marking

Represents total content. Layout may vary.



Asia-Pacific: TEL +886-2 25624117 • FAX +886-2 25624116

Europe: TEL +41-41 7685555 • FAX +41-41 7685510

The Americas: TEL +1-951 781-5500 • FAX +1-951 781-5700

www.bourns.com

MF-USMF SERIES, REV. M, 04/10

"freeXpansion Design" is a trademark of Bourns, Inc.
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MF-USMF Series Tape and Reel Specifications



MF-USMF Series per EIA 481-2

Tape Dimensions

W	$\frac{8.0 \pm 0.3}{(0.315 \pm 0.012)}$
P ₀	$\frac{4.0 \pm 0.1}{(0.157 \pm 0.004)}$
P ₁	$\frac{4.0 \pm 0.1}{(0.157 \pm 0.004)}$
P ₂	$\frac{2.0 \pm 0.05}{(0.079 \pm 0.002)}$
A ₀	$\frac{2.76 \pm 0.10}{(0.109 \pm 0.004)}$
B ₀	$\frac{3.50 \pm 0.10}{(0.138 \pm 0.004)}$
B ₁ max.	$\frac{4.35}{(0.171)}$
D ₀	$\frac{1.5 + 0.1/-0.0}{(0.059 + 0.004/-0)}$
F	$\frac{3.5 \pm 0.05}{(0.138 \pm 0.002)}$
E ₁	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
E ₂ min.	$\frac{6.25}{(0.246)}$
T max.	$\frac{0.6}{(0.024)}$
T ₁ max.	$\frac{0.1}{(0.004)}$
K ₀	$\frac{1.07 \pm 0.10}{(0.042 \pm 0.004)}$
Leader min.	$\frac{390}{(15.35)}$
Trailer min.	$\frac{160}{(6.30)}$

Reel Dimensions

A max.	$\frac{185}{(7.283)}$
N min.	$\frac{50}{(1.97)}$
W ₁	$\frac{8.4 + 1.5/-0.0}{(0.331 + 0.059/-0.0)}$
W ₂ max.	$\frac{14.4}{(0.567)}$



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